

### Standard recovery rectifier diode in bare die form

### Rev 1.0 25/08/23

## Features:

- Low leakage current
- High forward surge current capability
- Low forward voltage drop
- Robust construction
- High reliability tested grades.

# Ordering Information

The following part suffixes apply:

- No suffix MIL-STD-750 /2073 Visual Inspection
- "H" MIL-STD-750 /2073 Visual Inspection + MIL-PRF-38534 Class H LAT
- "K" MIL-STD-750 /2073 Visual Inspection + MIL-PRF-38534 Class K LAT

LAT = Lot Acceptance Test.

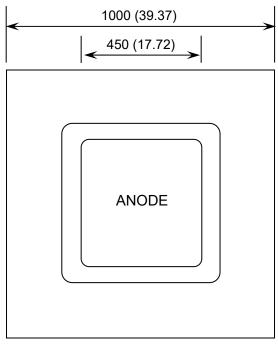
For further information on LAT process flows see below.

www.siliconsupplies.com\quality\bare-die-lot-qualification

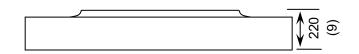
## Supply Formats:

- Default Die in Waffle Pack (400 per tray capacity)
- Sawn Wafer on Tape By specific request
- Unsawn Wafer By specific request
- With additional electrical selection By specific request

## Die Dimensions in µm (mils)



CHIP BACKSIDE IS CATHODE



# **Mechanical Specification**

Die Size (Unsawn)	1000 x 1000 39.37 x 39.37	µm mils	
Anode Pad Size	450 x 450 17.72 x 17.72	µm mils	
Die Thickness	220 (±20) 8.66 (±0.79)	µm mils	
Top Metal Composition	Al 7.5µm		
Back Metal Composition	Ti/Ni/Ag		





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#### Absolute Maximum Ratings T<sub>J</sub> = 25°C unless otherwise stated

PARAMETER	SYMBOL	VALUE	UNIT
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	400	V
DC Blocking Voltage	VR	400	V
RMS Reverse Voltage	V <sub>R (RMS)</sub>	280	V
Average forward rectified current	I <sub>F(AV)</sub> , T <sub>J</sub> = 75°C	1	A
Peak forward surge current <sup>1</sup>	I <sub>FSM</sub>	30	A
Operating Junction temperature	TJ	-55 to 175	°C
Storage Temperature Range	T <sub>STG</sub>	-65 to 200	°C

### **Electrical Characteristics** T<sub>J</sub> = 25°C unless otherwise stated

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT	
Maximum instantaneous Forward Voltage <sup>2</sup>	VF	I <sub>F</sub> = 1A	-	-	1.1	V	
Maximum Reverse Leakage Current I <sub>RM</sub> @ V <sub>RRM</sub>		V <sub>RRM</sub> = 400V, T <sub>J</sub> = 25°C	-	-	5	μA	
	$V_{RRM}$ = 400V, $T_{J}$ = 100°C	-	-	50	μΛ		
Maximum Junction Capacitance	CJ	V <sub>R</sub> = 0, f = 1.0MHz	-	-	40	pF	

1. Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load

2. Pulse Width = 3.8ms

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